NB7HQ14M

2.5V 7GHz / 10Gbps **Differential Input to 1.8V /** 2.5V 1:4 CML Clock / Data Fanout Buffer w/ Selectable Input Equalizer

Multi-Level Inputs w/ Internal Termination

Description

The NB7HQ14M is a high performance differential 1:4 CML fanout buffer with a selectable Equalizer receiver. When placed in series with a Clock /Data path operating up to 7 GHz or 10 Gb/s, respectively, the NB7HQ14M inputs will compensate the degraded signal transmitted across a FR4 PCB backplane or cable interconnect and output four identical CML copies of the input signal. Therefore, the serial data rate is increased by reducing Inter-Symbol Interference (ISI) caused by losses in copper interconnect or long cables. The EQualizer ENable pin (EQEN) allows the IN/IN inputs to either flow through or bypass the Equalizer section. Control of the Equalizer function is realized by setting EQEN; When EQEN is set Low, the IN/IN inputs bypass the Equalizer. When EQEN is set High, the IN/IN inputs flow through the Equalizer. The default state at start-up is LOW. As such, NB7HQ14M is ideal for SONET, GigE, Fiber Channel, Backplane and other Clock/Data distribution applications.

The differential inputs incorporate internal 50 Ω termination resistors that are accessed through the VT pin. This feature allows the NB7HQ14M to accept various logic level standards, such as LVPECL, CML or LVDS. The outputs have the flexibility of being powered by either a 2.5 V or 1.8 V supply. The 1:4 fanout design was optimized www.Datforhow/output skew applications.

> The NB7HQ14M is a member of the GigaComm[™] family of high performance clock products.

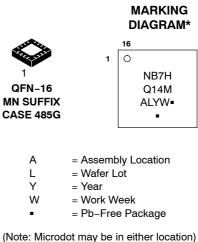
Features

- Input Data Rate > 10 Gb/s
- Input Clock Frequency > 7 GHz
- 150 ps Typical Propagation Delay
- 35 ps Typical Rise and Fall Times
- < 15 ps Maximum Output Skew
- < 0.8 ps Maximum RMS Clock Jitter
- < 10 ps pp of Data Dependent Jitter
- Differential CML Outputs, 400 mV Peak-to-Peak, Typical
- Selectable Input Equalization
- Operating Range: $V_{CC} = 2.375$ V to 2.625 V, $V_{CCO} = 1.71$ V to 2.625 V
- Internal Input Termination Resistors, 50Ω
- -40°C to +85°C Ambient Operating Temperature
- These are Pb-Free Devices



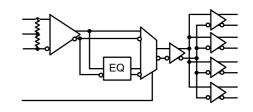
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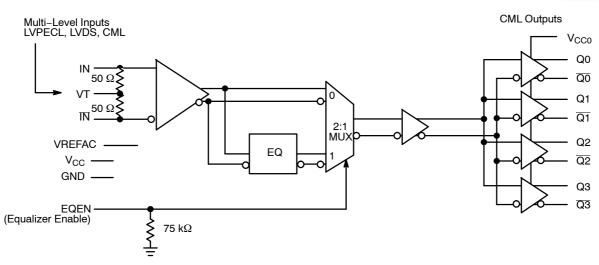
*For additional marking information, refer to Application Note AND8002/D.

SIMPLIFIED BLOCK DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 9 of this data sheet.





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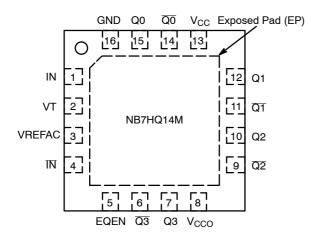


Figure 2. QFN-16 Pinout (Top View)

Table 2. PIN DESCRIPTION

www.

Table 1. EQUALIZER ENABLE FUNCTION

EQEN	EN Function				
0	IN / $\overline{\text{IN}}$ Inputs By–pass the Equalizer section				
1	Inputs flow through the Equalizer				

Pin	Name	I/O	Description
1	IN	LVPECL, CML, LVDS Input	Non-inverted Differential Input. Note 1.
2	VT		Internal 100 Ω Center-tapped Termination Pin for IN / $\overline{\text{IN}}$
3	VREFAC		Output Voltage Reference for Capacitor-Coupled Inputs, only
4	ĪN	LVPECL, CML, LVDS Input	Inverted Differential Input. Note 1.
5	EQEN	LVCMOS Input	Equalizer Enable Input; pin will default LOW when left open (has internal pull-down resistor)
6	<u>Q3</u>	CML Output	Inverted Differential Output. Typically Terminated with 50 Ω Resistor to $V_{CC}.$
7	Q3	CML Output	Non-inverted Differential Output. Typically Terminated with 50 Ω Resistor to V $_{CC}$
8	VCCO	-	1.8 V or 2.5 V Positive Supply Voltage for the Qn / Qn CML Outputs
9	<u>Q2</u>	CML Output	Inverted Differential Output. Typically Terminated with 50 Ω Resistor to $V_{CC}.$
10	Q2	CML Output	Non-inverted Differential Output. Typically Terminated with 50 Ω Resistor to V $_{CC}$
11		CML Output	Inverted Differential Output. Typically Terminated with 50 Ω Resistor to $V_{CC}.$
12	Q1	CML Output	Non-inverted Differential Output. Typically Terminated with 50 Ω Resistor to V $_{CC}$
13	VCC	-	2.5 V Positive Supply Voltage for the core
14	<u>Q0</u>	CML Output	Inverted Differential Output. Typically Terminated with 50 Ω Resistor to $V_{CC}.$
15	Q0	CML Output	Non-inverted Differential Output. Typically Terminated with 50 Ω Resistor to V $_{CC}$
16	GND	-	Negative Supply Voltage
-	EP	_	The Exposed Pad (EP) on the QFN-16 package bottom is thermally connected to the die for improved heat transfer out of package. The exposed pad must be attached to a heat-sinking conduit. The pad is electrically connected to the die, and must be electrically and thermally connected to GND on the PC board.

1. In the differential configuration when the input termination pin (VT) is connected to a common termination voltage or left open, and if no signal is applied on IN / IN input, then, the device will be susceptible to self–oscillation.

2. All VCC, VCCO and GND pins must be externally connected to a power supply for proper operation.

Table 3. ATTRIBUTES

Characteristic	Value				
ESD Protection Human Body Model Machine Model		> 2 kV > 200V			
R _{PD} – EQEN Input Pulldown Resistor	ulldown Resistor				
Moisture Sensitivity (Note 3)	16–QFN	Level 1			
Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in			
Transistor Count		290			
Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test					

3. For additional information, see Application Note AND8003/D.

Table 4. MAXIMUM RATINGS

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V _{CC}	Positive Power Supply – Core	GND = 0 V		3.0	V
V _{CCO}	Positive Power Supply – Outputs	GND = 0 V		3.0	V
V _{IO}	Positive Input/Output Voltage	GND = 0 V		-0.5 to V _{CC} + 0.5	V
V _{INPP}	Differential Input Voltage IN - IN			1.89	V
I _{IN}	Input Current Through R_T (50 Ω Resistor)			±40	mA
I _{OUT}	Output Current Through R_T (50 Ω Resistor)			±40	mA
IVFREFAC	VREFAC Sink/Source Current			±1.5	mA
T _A	Operating Temperature Range	16 QFN		-40 to +85	°C
T _{stg}	Storage Temperature Range			-65 to +150	°C
θ_{JA}	Thermal Resistance (Junction-to-Ambient) (Note 4)	0 lfpm 500 lfpm	16 QFN 16 QFN	42 35	°C/W °C/W
θ_{JC}	Thermal Resistance (Junction-to-Case) (Note 4)		16 QFN	4	°C/W
T _{sol}	Wave Solder Pb-Free			265	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability. 4. JEDEC standard multilayer board – 2S2P (2 signal, 2 power) with 8 filled thermal vias under exposed pad.

NB7HQ14M

Table 5. DC CHARACTERISTICS, MULTI-LEVEL INPUTS V_{CC} = 2.375 V to 2.625 V; V_{CCO} = 1.71 V to 2.625 V; GND = 0 V;

 $T_A = -40^{\circ}C$ to $85^{\circ}C$ (Note 5)

Symbol	Characteristic	Min	Тур	Max	Unit				
POWER S	POWER SUPPLY / CURRENT								
V _{CC} V _{CCO}	Power Supply Voltage $V_{CC} = 2.5 V \\ V_{CCO} = 2.5 V \\ V_{CCO} = 1.8 V$	2.375 2.375 1.71	2.5 2.5 1.8	2.625 2.625 1.89	V				
I _{CC} I _{CCO}	Power Supply Current for VCC (Inputs and Outputs Open) Power Supply Current for VCCO (Inputs and Outputs Open)		95 65	135 85	mA				
CML OUT	PUTS (Note 6)	_			-				

V _{OH}	Output HIGH Voltage	V _{CCO} = 2.5 V V _{CCO} = 1.8 V	V _{CCO} – 30 2470 1770	V _{CCO} – 10 2490 1790	V _{CCO} 2500 1800	mV	
V _{OL}	Output LOW Voltage	V _{CCO} = 2.5 V V _{CCO} = 1.8 V	V _{CCO} – 550 1950 1250	V _{CCO} – 400 2100 1400	V _{CCO} – 300 2200 1500	mV	

DIFFERENTIAL INPUT DRIVEN SINGLE-ENDED (see Figure 5 & 7) (Note 7)

VIH	Single-ended Input HIGH Voltage	Vth + 100	V _{CC}	mV
VIL	Single-ended Input LOW Voltage	GND	Vth -100	mV
V _{th}	Input Threshold Reference Voltage Range (Note 8)	1100	V _{CC} – 10	0 mV
V _{ISE}	Single-ended Input Voltage Amplitude (VIH - VIL)	200	2800	mV
VDEEAC				

VREFAC

V _{REFAC}	Output Reference Voltage @100 μA for capacitor– coupled inputs, only	$V_{CC} - 1325$	V _{CC} - 1125	$V_{CC}-925$	mV
DIFFEREN					

DIFFERENTIAL INPUTS DRIVEN DIFFERENTIALLY (see Figure 6 & 8) (Note 9)

V _{IHD}	Differential Input HIGH Voltage	1200	V _{CC}	mV
V _{ILD}	Differential Input LOW Voltage	0	V _{IHD} – 100	mV
V _{ID}	Differential Input Voltage (V _{IHD} – V _{ILD})	100	1200	mV
V _{CMR}	Input Common Mode Range (Differential Configuration) (Note 10) (Figure 9)	1050	V _{CC} – 50	mV
I _{IH}	Input HIGH Current IN / IN, (VT Open)	-150	150	uA
I _{IL}	Input LOW Current IN / IN, (VT Open)	-150	150	uA

www.DataSheet411 COMPUTS (EQEN)

V _{IH}	Input HIGH Voltage for Control Pins	V _{CC} x 0.65	V _{CC}	V
VIL	Input LOW Voltage for Control Pins	GND	V _{CC} x 0.35	V
I _{IH}	Input HIGH Current	-150	150	μΑ
IIL	Input LOW Current	-150	150	μΑ

TERMINATION RESISTORS

R _{TIN}	Internal Input Termination Resistor	45	50	55	Ω
R _{TOUT}	Internal Output Termination Resistor	45	50	55	Ω

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

5. Input parameters vary 1:1 with V_{CC}. Output parameters vary 1:1 with V_{CCO}. 6. CML outputs loaded with 50 Ω to V_{CCO} for proper operation.

7. Vth, V_{IH} , V_{IL} , and V_{ISE} parameters must be complied with simultaneously.

8. Vth is applied to the complementary input when operating in single-ended mode.

9. V_{IHD}, V_{ILD}, V_{ID} and V_{CMR} parameters must be complied with simultaneously.

10. V_{CMR} min varies 1:1 with GND, V_{CMR} max varies 1:1 with V_{CC}. The V_{CMR} range is referenced to the crosspoint side of the differential input signal.

					,
Symbol	Characteristic	Min	Тур	Мах	Unit
f _{MAX}	$\label{eq:Vourier} \mbox{Maximum Input Clock Frequency;} \qquad \qquad \mbox{V}_{\mbox{OUT}} \geq 200 \mbox{ mV}$	7	10		GHz
f _{DATAMAX}	Maximum Operating Data Rate (PRBS23)	10	12		Gbps
V _{OUTPP}	$\begin{array}{llllllllllllllllllllllllllllllllllll$	200	400		mV
t _{PLH} , t _{PHL}	Propagation Delay IN to Q	120	170	225	ps
t _{SKEW}	Duty Cycle Skew (Note 12) Output – Output Within Device Skew Device to Device Skew		3	15 15 50	ps
t _{DC}	$\label{eq:constraint} \mbox{Output Clock Duty Cycle (Reference Duty Cycle = 50\%)} \qquad f_{in} \le 7 \mbox{GHz}$	40	50	60	%
$\Phi_{\sf N}$	Phase Noise, fin = 1 GHz 10 kHz 100 kHz 100 kHz 1 MHz 10 MHz 20 MHz 40 MHz		-135 -137 -149 -150 -150 -151		dBc
t _{∫ΦN}	Integrated Phase Jitter f _{in} = 1 GHz, 12 kHz - 20 MHz Offset (RMS)		50		fs
t _{JITTER}	$\label{eq:RMS} \text{RMS Random Clock Jitter (Note 13)} \qquad \qquad$		0.2	0.8	ps rms
	$\begin{array}{llllllllllllllllllllllllllllllllllll$			10 10	ps pk–pk ps pk–pk
V _{INPP}	Input Voltage Swing/Sensitivity (Differential Configuration) (Note 15)	100		1200	mV
t _r t _f	Output Rise/Fall Times @ 1.0 GHz Qx, Qx (20% - 80%) Qx	15	30	45	ps

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

11. Measured by forcing V_{INPP} 400mV from a 50% duty cycle clock source. All loading with an external $R_L = 50 \Omega$ to V_{CCO} . Input edge rates 40 ps (20% – 80%).

12. Skew is measured between outputs under identical transitions and conditions @ 0.5 GHz. Duty cycle skew is measured between differential W W W . D a toutputs using the deviations of the sum of Tpw- and Tpw+ @ 0.5 GHz.

13. Additive RMS jitter with 50% duty cycle clock signal.

14. Additive peak-to-peak data dependent jitter with input NRZ data at PRBS23.

15. Input and output voltage swings are single-ended measurements operating in a differential mode.

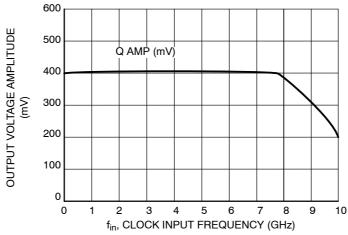
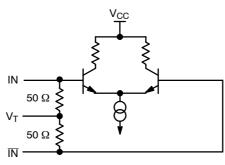
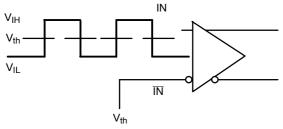
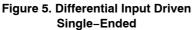


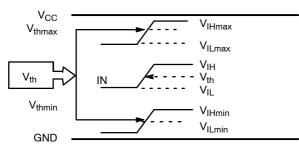
Figure 3. CLOCK Output Voltage Amplitude (V_{OUTPP}) vs. Input Frequency (f_{in}) at Ambient Temperature (Typical)





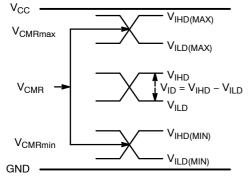




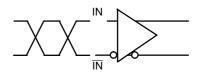




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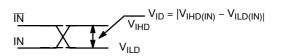
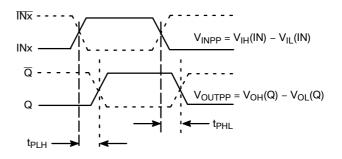
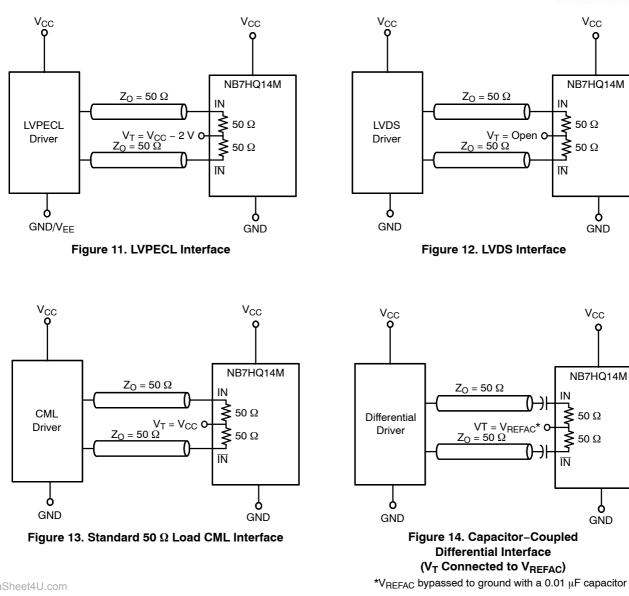


Figure 8. Differential Inputs Driven Differentially



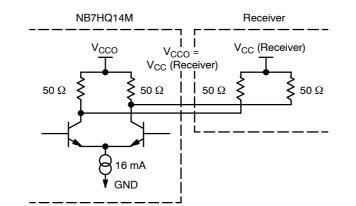




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V_CC V_{CC} o NB7HQ14M Z_O = 50 Ω IN \sim 50 Ω Differential VT = V_{REFAC}* O Driver 50 Ω IN Q Q GND GND Figure 15. Capacitor-Coupled Single-Ended Interface (V_T Connected to V_{REFAC})

NB7HQ14M





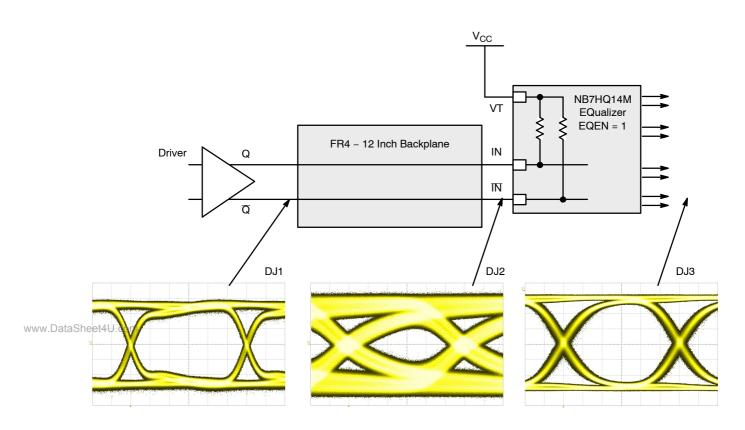


Figure 17. Typical NB7HQ14M Equalizer Application and Interconnect with PRBS23 pattern at 6.5 Gbps, EQEN = 1

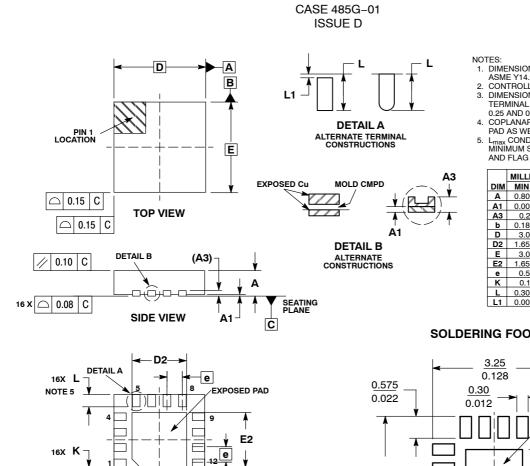
ORDERING INFORMATION

Device	Package	Shipping [†]
NB7HQ14MMNG	QFN-16 (Pb-Free)	123 Units / Rail
NB7HQ14MMNHTBG	QFN-16 (Pb-Free)	100 / Tape & Reel
NB7HQ14MMNTXG	QFN-16 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

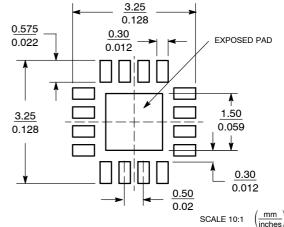
16 PIN QFN



- DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN
- 0.25 AND 0.30 MM FROM TERMINAL. COPLANARITY APPLIES TO THE EXPOSED
- PAD AS WELL AS THE TERMINALS. Lmax CONDITION CAN NOT VIOLATE 0.2 MM MINIMUM SPACING BETWEEN LEAD TIP

	MILLIMETERS	
DIM	MIN	MAX
Α	0.80	1.00
A1	0.00	0.05
A3	0.20 REF	
b	0.18	0.30
D	3.00 BSC	
D2	1.65	1.85
Е	3.00 BSC	
E2	1.65	1.85
е	0.50 BSC	
κ	0.18 TYP	
L	0.30	0.50
L1	0.00	0.15

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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